

# GP2S40

## Long Focal Distance, Subminiature Photointerrupter

### ■ Features

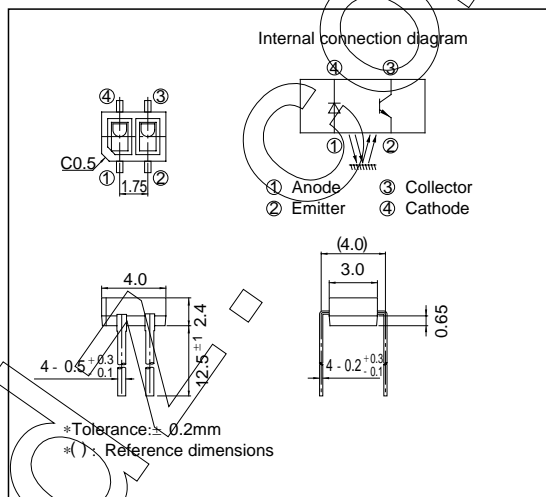
1. Ultra compact DIP package  
(Volume: 1/3 of **GP2S05**)
2. Long focal distance type  
(focal distance: 3mm)
3. Effective detection distance: 1.5 to 6.5mm

### ■ Applications

1. Copiers
2. Facsimiles
3. Printers

### ■ Outline Dimensions

(Unit: mm)

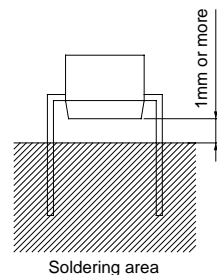


### ■ Absolute Maximum Ratings

( $T_a = 25^\circ\text{C}$ )

	Parameter	Symbol	Rating	Unit
Input	Forward current	$I_F$	50	mA
	Reverse voltage	$V_R$	6	V
	Power dissipation	$P_D$	75	mW
Output	Collector-emitter voltage	$V_{CEO}$	35	V
	Emitter-collector voltage	$V_{ECO}$	6	V
	Collector current	$I_C$	20	mA
	Collector power dissipation	$P_C$	75	mW
	Total power dissipation	$P_{tot}$	100	mW
	Operating temperature	$T_{opr}$	- 25 to + 85	$^\circ\text{C}$
	Storage temperature	$T_{stg}$	- 40 to + 100	$^\circ\text{C}$
	*1 Soldering temperature	$T_{sol}$	260	$^\circ\text{C}$

\*1 For 5 seconds



Electro-optical Characteristics

(Ta = 25°C)

Parameter		Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	$V_F$	$I_F = 20\text{mA}$	-	1.2	1.4	V
	Reverse current	$I_R$	$V_R = 3\text{V}$	-	-	10	$\mu\text{A}$
Output	Collector dark current	$I_{CEO}$	$V_{CE} = 20\text{V}$	-	1	100	nA
Transfer characteristics	Collector current	$I_C$	$V_{CE} = 5\text{V}, I_F = 20\text{mA}$	0.5	-	3.0	mA
	*2Leak current	$I_{LEAK}$	$V_{CE} = 5\text{V}, I_F = 20\text{mA}$	-	-	500	nA
	*3Response time		$V_{CE} = 2\text{V}, I_C = 100\mu\text{A}$	-	50	150	$\mu\text{s}$
		Rise time	$t_r$				
		Fall time	$t_f$		50	150	$\mu\text{s}$
			$R_L = 1\,000\Omega, d = 4\text{mm}$				

\*2 No reflective object  
\*3 “d” is glass thickness of reflective mirror.

Test Arrangement of Collector Current

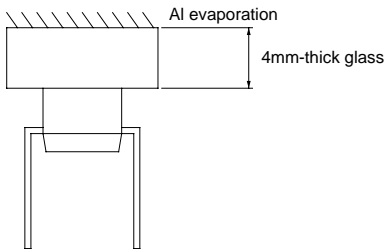


Fig. 1 Forward Current vs. Ambient Temperature

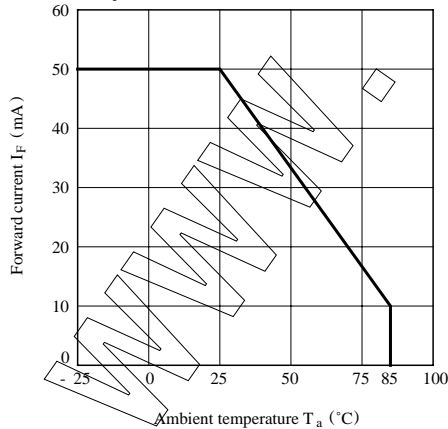


Fig. 2 Power Dissipation vs. Ambient Temperature

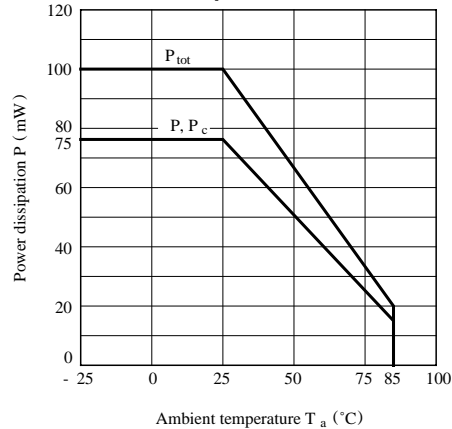


Fig. 3 Forward Current vs. Forward Voltage

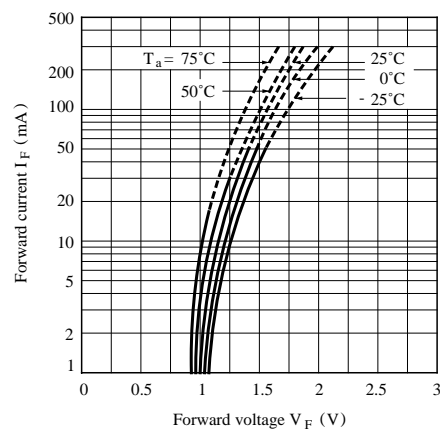


Fig. 4 Collector Current vs. Forward Current

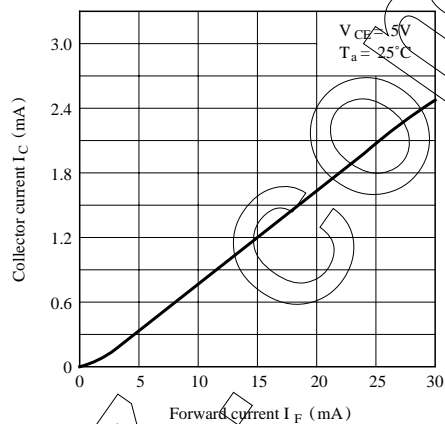


Fig. 5 Collector Current vs. Collector-emitter Voltage

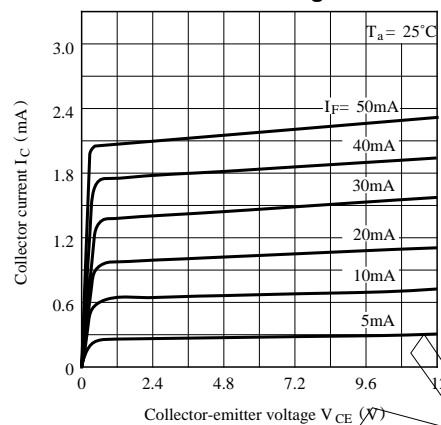


Fig. 6 Relative Collector Current vs. Ambient Temperature

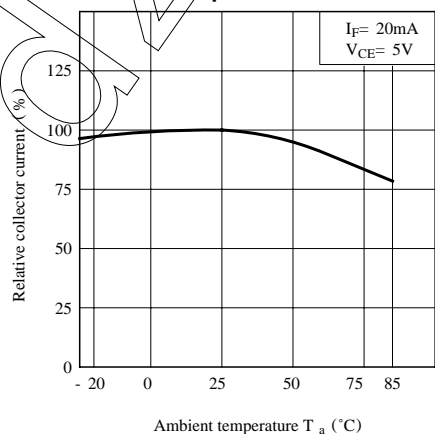
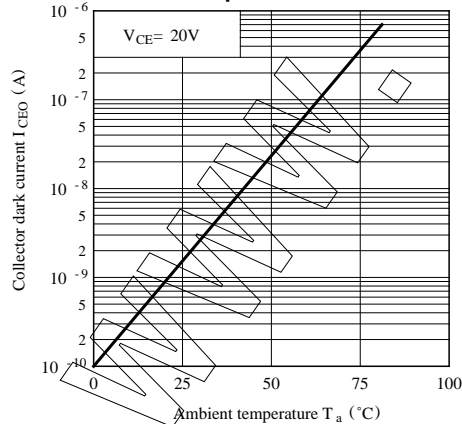
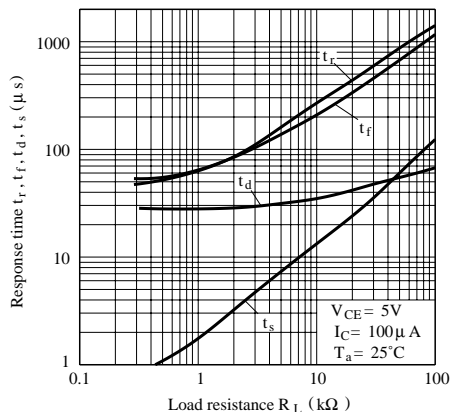


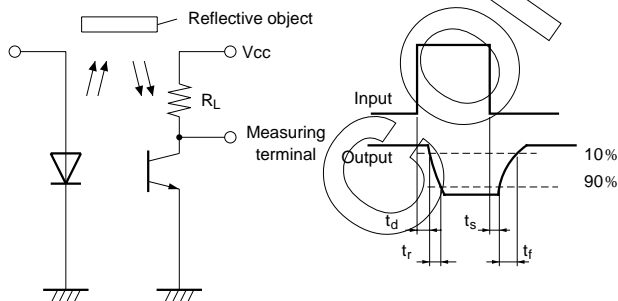
Fig. 7 Collector Dark Current vs. Ambient Temperature



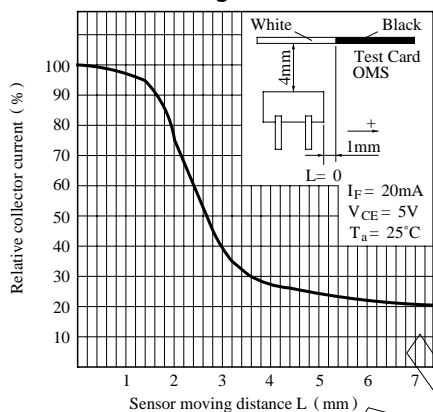
**Fig. 8 Response Time vs. Load Resistance**



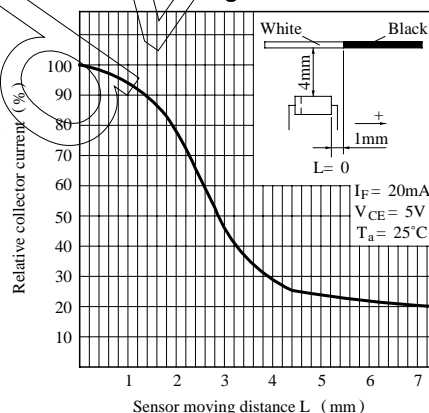
**Test Circuit for Response Time**



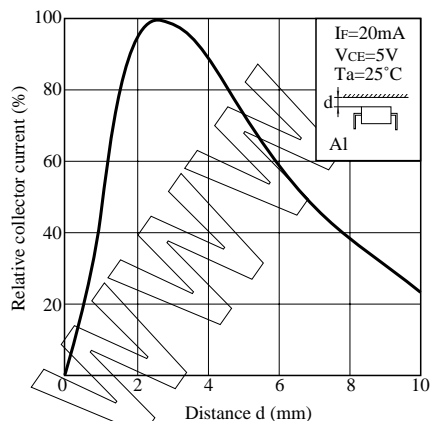
**Fig. 9 Relative Collector Current vs. Sensor moving Distance (1)**



**Fig.10 Relative Collector Current vs. Sensor moving Distance (2)**



**Fig. 11 Relative Collector Current vs. Distance**



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